

## 20V N-Channel Power MOSFET

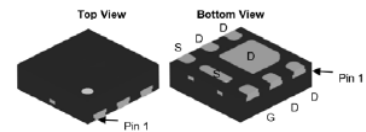
### DESCRIPTION :

- Excellent  $R_{DS(ON)}$
- Low Gate Charge
- 100% UIS Tested
- Pb-Free Lead Plating
- RoHS compliant

$V_{DSS}$	20V
$I_D (T_A=25^\circ\text{C})$	10A
$R_{DS(ON\_Typ.)@V_{GS}=4.5V}$	9.8m $\Omega$

### TYPICAL APPLICATIONS :

- Power Management
- Load Switch
- PMW Application



DFN2020-6L

### MAXIMUM RATINGS (at $T_A = 25^\circ\text{C}$ , unless otherwise specified)

Characteristic	Condition	Symbol	Value	Unit
Drain-Source Voltage		$V_{DS}$	20	V
Gate-Source Voltage		$V_{GS}$	$\pm 12$	V
Continuous Drain Current	$T_A=25^\circ\text{C}$ $T_A=100^\circ\text{C}$	$I_D$	10 6	A
Pulsed Drain Current <sup>(1)</sup>		$I_{DM}$	40	A
Avalanche Energy <sup>(2)</sup>		$E_{AS}$	30	mJ
Power dissipation	$T_A=25^\circ\text{C}$	$P_D$	2.7	W
Junction & Storage temperature Range		$T_J, T_{STG}$	-55~+150	$^\circ\text{C}$

Notes : 1. Repetitive Rating : Pulse Width Limited by Maximum Junction Temperature.

2.  $E_{AS}$  Condition : Starting  $T_J = 25^\circ\text{C}$ ,  $L = 0.5\text{mH}$ ,  $I_{AS} = 11\text{A}$ ,  $V_G = 10\text{V}$ ,  $V_{DD} = 10\text{V}$ ;  $R_G = 25\text{ohm}$

### THERMAL CHARACTERISTICS

Characteristic	Condition	Symbol	Value	Unit
Thermal resistance,	Junction to Ambient	$R_{\theta JA}$	46	$^\circ\text{C/W}$

ELECTRICAL CHARACTERISTICS (at  $T_J = 25\text{ }^\circ\text{C}$ , unless otherwise specified)

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage VGS = 0V, ID = 250uA	$V_{(BR)DSS}$	20			V
Zero Gate Voltage Drain Current VDS = 20 V, VGS = 0 V	$I_{DSS}$			1	uA
Gate-Source Leakage Current VGS = $\pm 12$ V, VDS = 0V	$I_{GSS}$			$\pm 100$	nA
Gate-Source threshold voltage VDS = VGS, ID = 250uA	$V_{GS(th)}$	0.5	0.75	1.0	V
Drain-Source On-State Resistance VGS = 4.5V, ID = 10A VGS = 2.5V, ID = 5A	$R_{DS(on)}$		7.5 9.6	9.8 12.5	m $\Omega$
Input capacitance f=1MHz, VDS=10 V, VGS=0 V	$C_{iss}$		1195		pF
Output capacitance f=1MHz, VDS=10 V, VGS=0 V	$C_{oss}$		175		pF
Reverse transfer capacitance f=1MHz, VDS=10 V, VGS=0 V	$C_{rss}$		150		pF
Total Gate Charge VDD= 10V, ID= 5A, VGS= 0 to 4.5V	$Q_G$		13		nC
Gate to Source Charge VDD= 10V, ID= 5A, VGS= 0 to 4.5V	$Q_{GS}$		2		nC
Gate to Drain Charge VDD= 10V, ID= 5A, VGS= 0 to 4.5V	$Q_{GD}$		3		nC
Turn-on delay time VDD= 10V, VGS= 4.5V, ID= 5A, $R_{GEN}=3\Omega$	$t_{d(ON)}$		7		ns
Rise time VDD= 10V, VGS= 4.5V, ID= 5A, $R_{GEN}=3\Omega$	$t_r$		25		ns
Turn-off delay time VDD= 10V, VGS= 4.5V, ID= 5A, $R_{GEN}=3\Omega$	$t_{d(OFF)}$		34		ns
Fall time VDD= 10V, VGS= 4.5V, ID= 5A, $R_{GEN}=3\Omega$	$t_f$		13		ns

## Body Diode

ELECTRICAL CHARACTERISTICS (at  $T_J = 25\text{ }^\circ\text{C}$ , unless otherwise specified)

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Diode Forward Voltage $V_{GS} = 0V, I_S = 10A$	$V_{SD}$			1.2	V
Maximum Continuous Body Diode Forward Current	$I_S$			10	A
Maximum Pulsed Body Diode Forward Current	$I_{SM}$			40	A
Revers Recovery Time $I_F = 5A, di/dt = 100A/\mu s$	$T_{rr}$		10		ns
Revers Recovery Charge $I_F = 5A, di/dt = 100A/\mu s$	$Q_{rr}$		2.7		nC

Typical Performance Characteristics

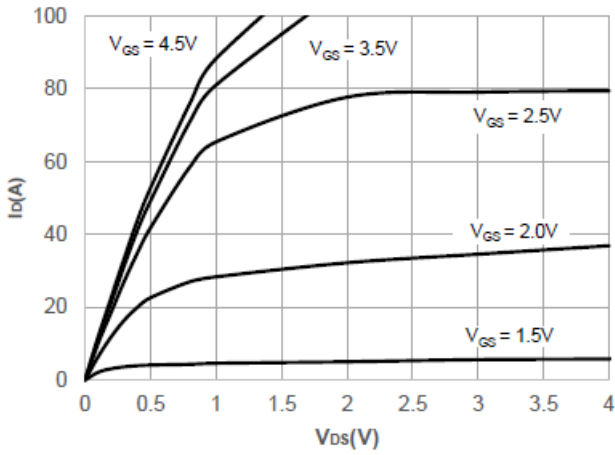


Figure 1. Output Characteristics

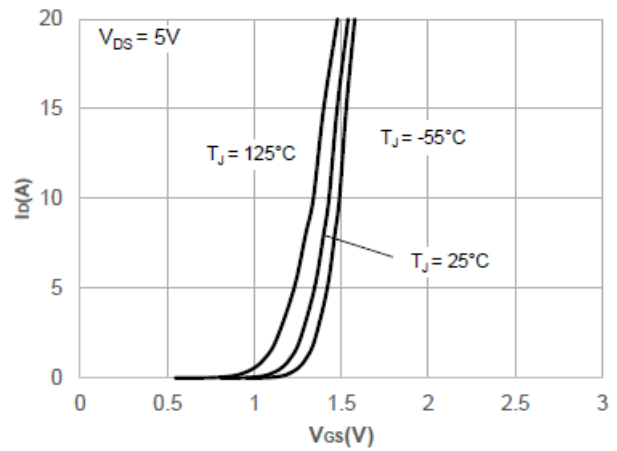


Figure 2. Transfer Characteristics

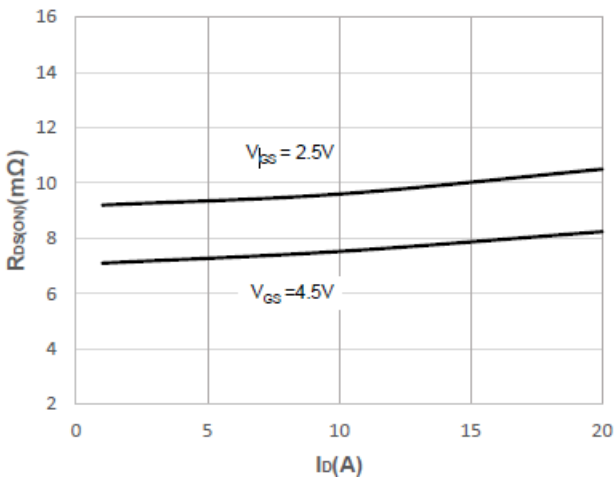


Figure 3. On-resistance vs. Drain Current

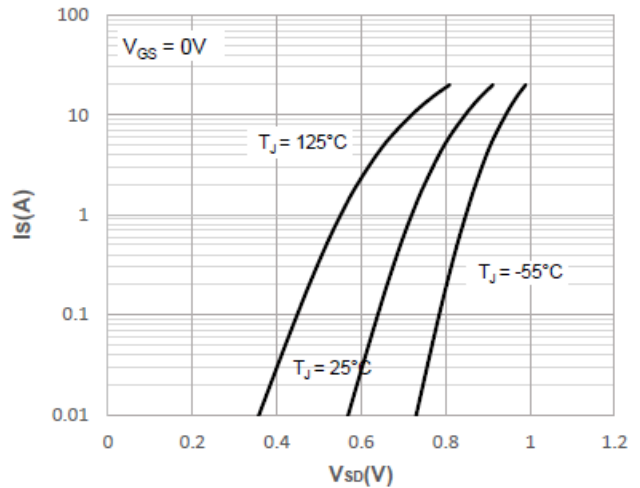


Figure 4. Body-Diode Characteristics

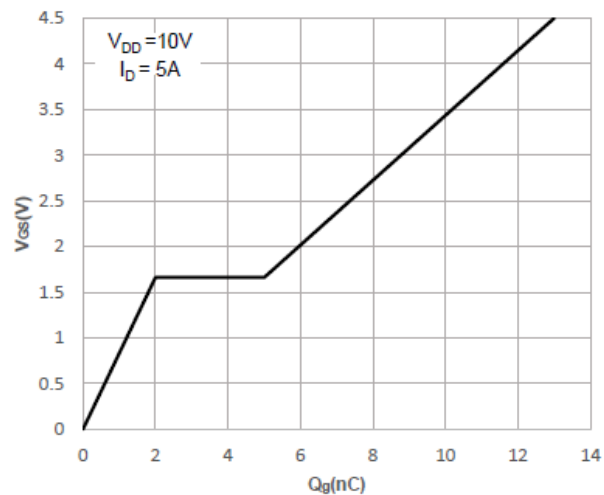


Figure 5. Gate Charge Characteristics

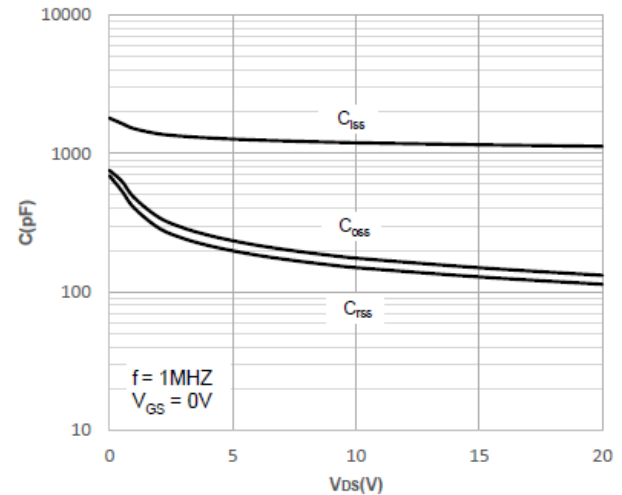


Figure 6. Capacitance Characteristics

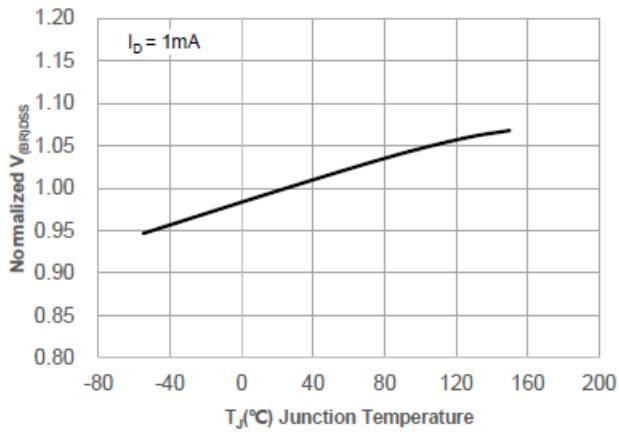


Figure 7. Normalized Breakdown voltage vs. Junction Temperature

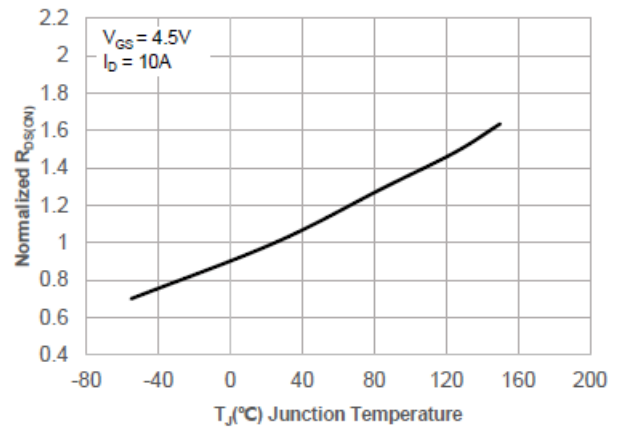


Figure 8. Normalized on Resistance vs. Junction Temperature

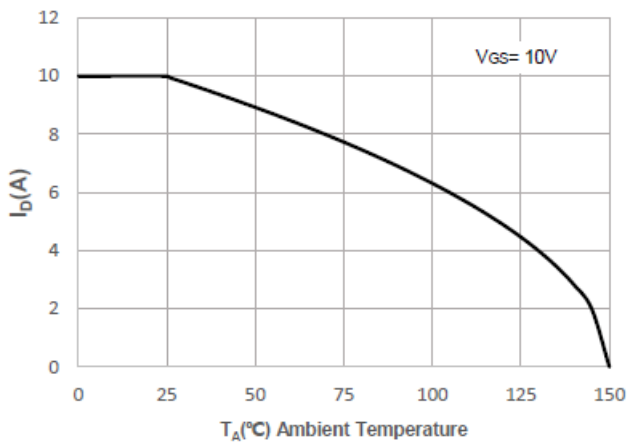


Figure 9. Maximum Continuous Drian Current vs. Case Temperature

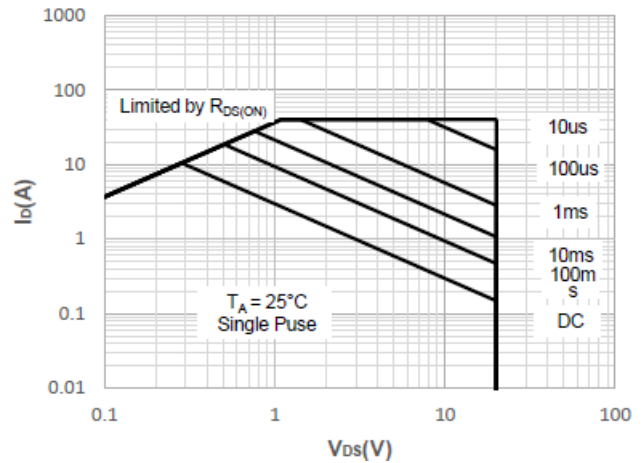


Figure 10. Maximum Safe Operating Area

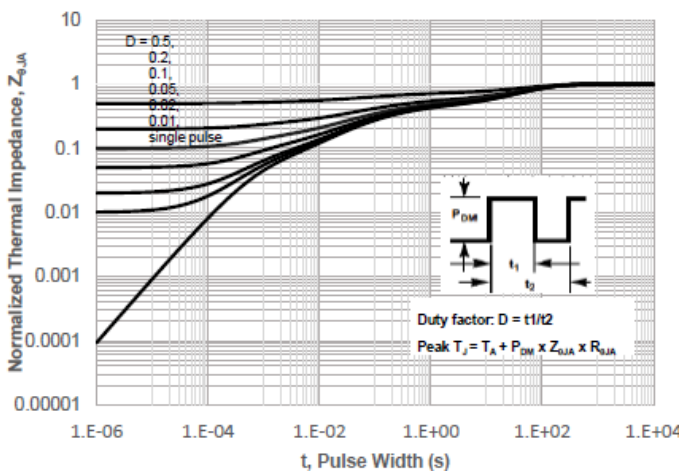


Figure 11. Normalized Maximum Transient Thermal Impedance

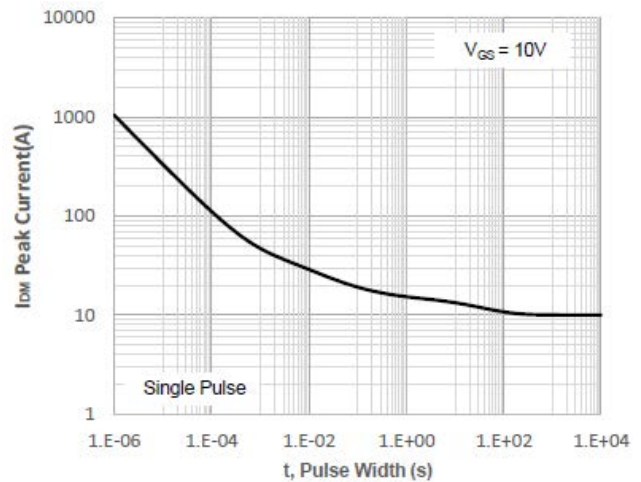
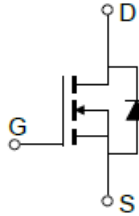
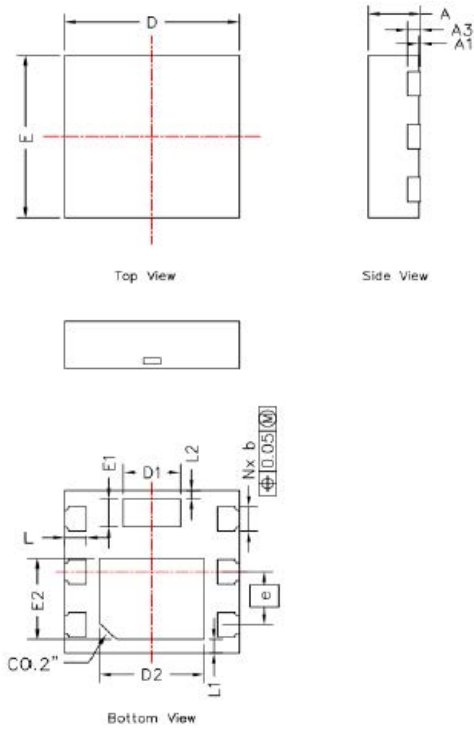


Figure 12. Peak Current Capacity

• Circuit diagram



• Package outlines :



SYMBOLS	DIMENSION IN MM			DIMENSION IN INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.700	0.750	0.800	0.028	0.030	0.031
A1	---	---	0.050	----	----	0.002
A3	0.195	0.203	0.211	0.008	0.008	0.008
b	0.250	0.300	0.350	0.010	0.012	0.014
e	0.65BSC			0.026 BSC		
D	1.900	2.000	2.100	0.075	0.079	0.083
E	1.900	2.000	2.100	0.075	0.079	0.083
D1	0.560	0.660	0.760	0.022	0.026	0.030
E1	0.250	0.350	0.450	0.010	0.014	0.018
D2	1.100	1.200	1.300	0.043	0.047	0.051
E2	0.900	1.000	1.100	0.035	0.039	0.043
L	0.150	0.250	0.350	0.006	0.010	0.014
L1	0.065	0.165	0.265	0.003	0.006	0.010
L2	0.000	0.100	0.200	0.000	0.004	0.008

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